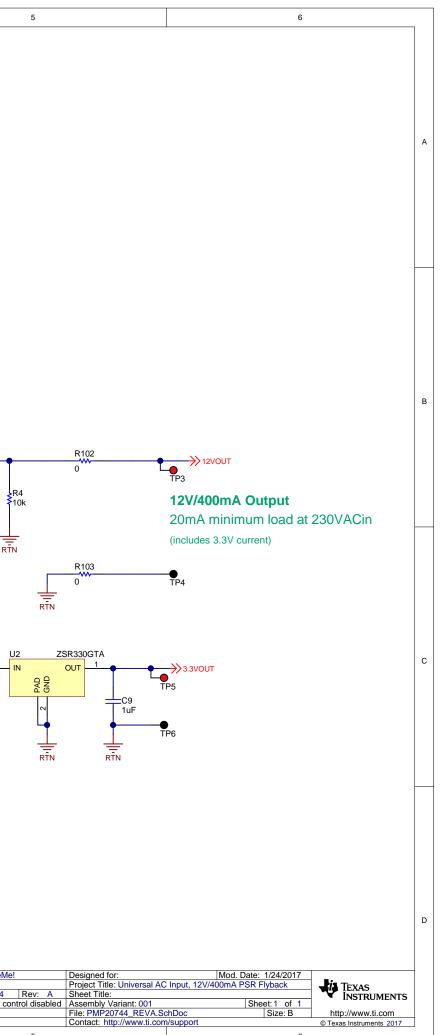
[1	2	3	4	
		Notes: 1) Built on PMP9074 Rev C PCB.				
		2) L1 does not match PCB footprint.				
	A					
				<u>L1</u>		
			- D1	<u>L1</u> 220µН		
		RF1	D1 DF06S	R1	C1 = 470pF 630V	
		LINE O	4 3 1+C2 4.7μF	+C3 10μF		
		85VAC-265VAC Inpu	л.			
					4007-G	
		NTRL O		R2 ≹200	1 T1	
	в			~200		
				•		
			D4 R3		PGND 4 3 1.8mH	+ + + +
			ММВД914 20			LC5 1uF 1uF 1uF 10F 10F 10F 10F
					C6	25V
			R5 \$54.9k	U1 Q1 PHE1300	03A,126 470pF	
			1			
			2	⊳ VS ⊳ CBC DRV 6	RTN	
	с		=10uF	UCC28720D		U2
			PGND PGND	2.2		3
			FUND FUND	PGND		C8
				PGND		25V
						RĪN
-						
	D					
						Orderable: ChangeMe!
			Texas Instruments and/or its licensor	s do not warrant the accuracy or completeness of this specification or any	information contained therein. Texas Instruments and/or its licensors d	TID #: N/A Number: PMP20744 o not SVN Rev: Version cont
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